

SN-US015055

DECLARATION

I, Shinpei Okajima, declare that I am a citizen of Japan, residing at 3-2-16, Midorigaoka, Izumi City, Osaka 594-1155, JAPAN, that I have read, reviewed and understand the contents of the foregoing specification and claims and I verily believe that I am the original, first and sole inventor of the invention entitled

SNOWBOARD BINDING SYSTEM

described and claimed in the foregoing specification; that I have reviewed and understand the content of the foregoing specification, including the claims; that I acknowledge my duty to disclose information of which I am aware which is material to the examination of this application in accordance with 37 CFR 1.56; and that no application for patent or inventor's certificate on this invention has been filed by me or my representatives or assigns in any country foreign to the United States, except as follows:

Prior Foreign Application(s)	Priority Claimed		
* (Number)	* (Country)	* (Date Filed)	* Yes No

I hereby claim the benefit under 35 U.S.C. § 120 of any U.S. application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application(s) in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose material information as defined in 37 C.F.R. § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

* (Application Serial No.)	* (Filing Date)	* (Status)
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The undersigned declares further that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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